



[10191/3081]

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant(s) : GOMEZ et al. Confirmation No.: 7307  
Serial No. : 10/618,795  
Filed : July 14, 2003  
Title : MICROSTRUCTURED COMPONENT AND  
METHOD FOR ITS MANUFACTURE  
Art Unit : 1772  
Examiner : D. Loney  
Customer No. : 26646

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Date: 9/26/06

Signature: R. Harner

**AMENDMENT** after Final

SIR:

In response to the Office Action dated April 18, 2006, please amend the  
above-referenced application as set forth below.

**Amendments to the Specification** do not appear in this paper.

**Amendments to the Claims** are reflected in the listing of the claims which begins on page 2  
of this paper.

**Amendments to the Drawings** do not appear in this paper.

**Remarks** begin on page 4 of this paper.